Product End-of-Life Disassembly Instructions

Product Category: Personal Computers
Marketing Name / Model **[List multiple models if applicable.]**
HP Chromebox PC
HP Chromebox G1 PC

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.
1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	2
Batteries	All types including standard alkaline and lithium coin or button style batteries	1
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height		0
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations.	0 0
Components and waste containing asbestos		0
Components, parts and materials containing		0

PSG instructions for this template are available at EL-MF877-01

refractory ceramic fibers		
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Description Screwdriver	#1,#0
Description #2	
Description #3	
Description #4	
Description #5	

3.0 Product Disassembly Process

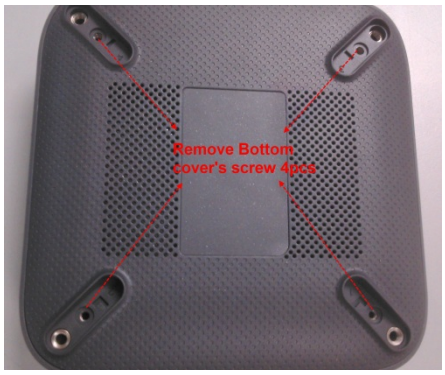
3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Release Rubber foot.fig#1
2. Release Bottom Cover's screw.fig#2
3. Remove Bottom Cover.fig#3
4. Release Bottom BKT's screw.fig#4
5. Remove Bottom BKT and Release Top BKT to Top cover's screw.fig#5
6. Release Top BKT form Top Cover.fig#6
7. Release MB to Top BKT's screw and disassembly MB.fig#7
8. Release Thermal modue and FAN.fig#8
9. Total disassembly finish.fig#9
10.
11.
12.
13.
14.
15.

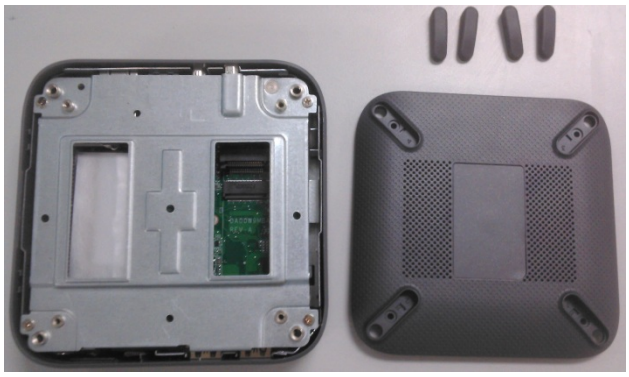
3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

1. Release Rubber foot.

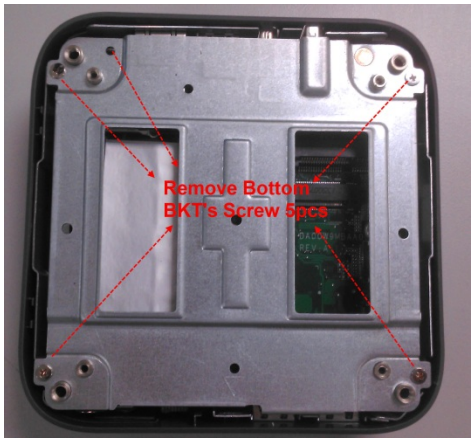
2. Release Bottom Cover's screw



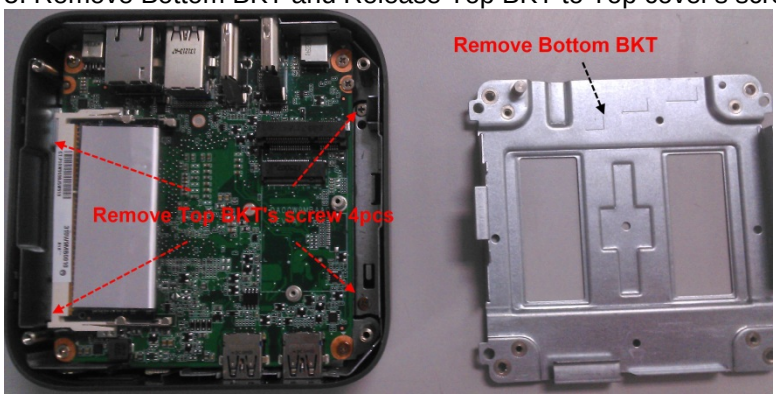
3. Remove Bottom Cover



4 Release Bottom BKT's screw

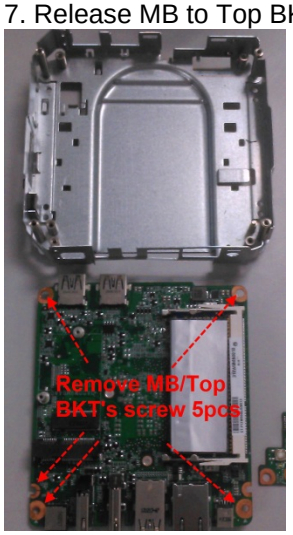


5. Remove Bottom BKT and Release Top BKT to Top cover's screw

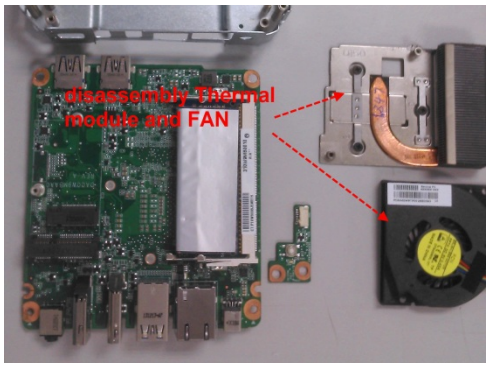


6. Release Top BKT form Top Cover

7. Release MB to Top BKT's screw and disassembly MB.



8. Release Thermal module and FAN



9. Total disassembly finish